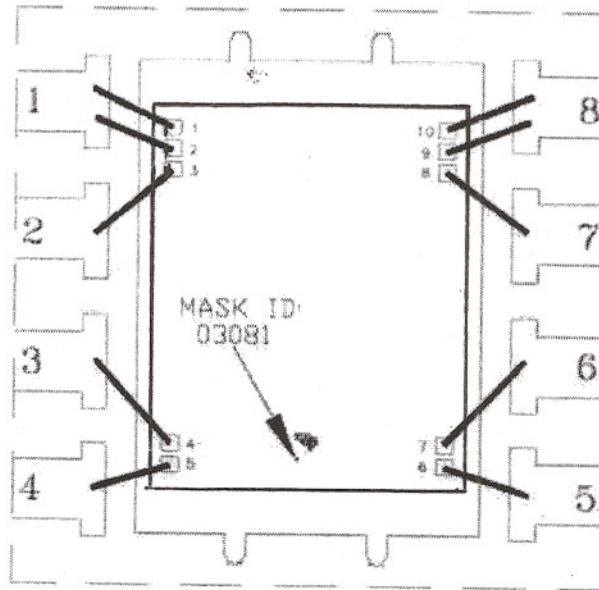




Sierra Components, Inc.

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Chip back potential is the level which bulk silicon is maintained by on-chip connection, or it is the level to which the chip back must be connected when specifically stated below. If no potential is given the chip back should be isolated.



Topside Metal: Aluminum
Backside Metal: Silicon
Backside Potential:
Bond Pad Size: .004" min.
Mask Ref:

APPROVED BY: D Markham

DIE SIZE : .063" X .077"

DATE: 5/4/05

MFG: Burr Brown (T.I.)

THICKNESS: .012"

P/N: DAC8532